



## SYLGARD™527 Silicone Dielectric Gel

Two-part, 1 to 1 mix ratio dielectric gel

### Features & Benefits

- Room temperature or heat accelerated cure
- Available in clear or red
- Heat cure for increased processing speeds
- Low viscosity allows good flow under components

### Composition

- Polydimethylsiloxane gel

### Applications

- SYLGARD™ 527 Silicone Dielectric Gel is suitable for sealing and protecting various PCB system assemblies, especially those with delicate components

### Typical Properties

Specification Writers: These values are not intended for use in preparing specifications.

Property	Unit	Result
One part or Two part		Two
Color		Clear or red
Viscosity Part A	cP	470
Viscosity Part B	cP	454
Viscosity (Mixed)	cP	465
Specific Gravity (Uncured)		0.95
Working Time at 25°C (Pot Life - Hours)	hr	1.98
Heat Cure Time (T90) at 100°C	minutes	210
Heat Cure Time (T90) at 125°C	minutes	75
Heat Cure Time (T90) at 150°C	minutes	35
Gel Hardness	grams	113
Penetration (¼ cone)	mm/10	55
Dielectric Strength	volts/mils kV/mm	425 17
Dielectric Constant at 100 Hz		2.85
Dielectric Constant at 100 kHz		2.85

## Typical Properties (Cont.)

Property	Unit	Result
Volume Resistivity	ohm*cm	2.75E+15
Dissipation Factor at 100 Hz		0.002
Dissipation Factor at 100 kHz		0.0001
Linear CTE (by TMA)	ppm/°C	335

### Description

Two-part gels offer more processing flexibility with the options of room-temperature with no need for ovens or heat-accelerated cure if faster processing is protect by coating, encapsulating or potting various PCB system assemblies, especially those with delicate components. Gels are a special class of encapsulant that cure to an extremely soft material. Gels cure in place to materials. Cured gels retain much of the stress relief and self-healing qualities of a liquid while providing the dimensional stability of an elastomer which is increasingly needed for delicate components. Gels have been used to isolate circuits from the harmful effects of moisture and other contaminants and provide electrical insulation for high voltages. Another use is providing stress relief to protect circuits and interconnections from thermal and mechanical stresses. Gels are usually applied in thick layers to totally encapsulate higher architectures. More recently, gels have found application in optoelectronics due to their stress relieving capability and high refractive index, as well as the stability of these properties over time.

### Mixing and De-Airing

Some gels are supplied in bladder packs that avoid direct air contact with the liquid gel components, allowing use of air pressure over the pack in a pressure pot for dispensing. Do not apply air pressure directly to the liquid gel surface (without the bladder pack) as the gel can become supersaturated with air and bubbling can occur when the material is dispensed and cured. Use of bladder packs prevents bubbling, maintains cleanliness and avoids gel contamination. Gels can be dispensed manually or by using one of the available types of meter mix equipment. Typically, the two components are of matched viscosities and are readily mixed with static or dynamic mixers, with automated meter-mix normally used for high volume processes. For low-volume applications, manual weighing and simple hand mixing may be appropriate. Inaccurate proportioning or inadequate mixing may cause localized or widespread problems affecting the gel properties or cure characteristics. If possible, the potential for entrapment and incorporation of gas (typically air) should be considered during design of the part and selection of a process to mix and dispense the gel. This is especially important with higher-viscosity and faster-curing gels. Degassing at > 28 inches (10–20 mm) Hg vacuum may be necessary to ensure a void-free, protective layer.

### Pot Life and Cure Rate

Working time (or pot life) is the time required for the initial mixed viscosity to double at room temperature (RT). The cure reaction begins when Parts A and B are mixed. As the cure progresses, viscosity increases until the material becomes a soft gel. Cure is defined as the time required for a specific gel to reach 90% of its final properties Gels will reach a no-flow state prior to full cure. Addition-cure silicone gels may be room temperature and heat cure or exclusively heat cure. Adding heat accelerates the cure reaction. Additional time should be allowed for heating the part to near oven temperature. Cure schedules should be verified in each new application.

## **Useful Temperature Ranges**

For most uses, silicone gels should be operational over a temperature range of -45 to 150°C (-49 to 302°F) for long periods of time. However, at both the low- and high temperature ends of the spectrum, behavior of the materials and performance in particular applications can become more complex and require additional considerations. For low-temperature performance, thermal cycling to conditions such as -55°C (-67°F) may be possible, but performance should be verified for your parts or assemblies. Factors that may influence performance are configuration and stress sensitivity of components, cooling rates and hold times, and prior temperature history. At the high-temperature end, the durability of the cured silicone elastomer is time and temperature dependent. As expected, the higher the temperature, the shorter the time the material will remain useable.

## **Compatibility**

Certain materials, chemicals, curing agents and plasticizers can inhibit the cure of addition cure gels. Most notable of these include: organotin and other organometallic compounds, silicone rubber containing organotin catalyst, sulfur, polysulfides, polysulfones or other sulfur containing materials, unsaturated hydrocarbon plasticizers, and some solder flux residues. If a substrate or material is questionable with respect to potentially causing inhibition of cure, it is recommended that a small scale compatibility test be run to ascertain suitability in a given application. The presence of liquid or uncured product at the interface between the questionable substrate and the cured gel indicates incompatibility and inhibition of cure.

## **Repairability**

In the manufacture of PCB system assemblies, salvage or rework of damaged or defective units is often required. Removal of Dow dielectric gels to allow necessary repairs can be assisted by using Dow OS fluids. Additional information regarding these products is available from Dow. In addition, if only one component needs to be replaced, a soldering iron may be applied directly through the gel to remove the component. After work has been completed, the repaired area should be cleaned with forced air or a brush, dried, and patched with additional silicone gel.

## **Handling Precautions**

PRODUCT SAFETY INFORMATION REQUIRED FOR SAFE USE IS NOT INCLUDED IN THIS DOCUMENT. BEFORE HANDLING, READ PRODUCT AND SAFETY DATA SHEETS AND CONTAINER LABELS FOR SAFE USE, PHYSICAL AND HEALTH HAZARD INFORMATION. THE SAFETY DATA SHEET IS AVAILABLE ON THE DOW WEBSITE AT DOW.COM, OR FROM YOUR DOW SALES APPLICATION ENGINEER, OR DISTRIBUTOR, OR BY CALLING DOW CUSTOMER SERVICE.

## **Usable Life and Storage**

Shelf life is indicated by the "Use Before" date found on the product label. Refer to the product label for storage temperature requirements. Special precautions must be taken to prevent moisture from contacting these materials. Containers should be kept tightly closed and head or air space minimized. Partially filled containers should be purged with dry air or other gases, such as nitrogen. Exposure to moisture could reduce adhesion and cause bubbles to form.

## **Packaging Information**

In general, Dow dielectric gels are available in batch-matched kits containing both Part A and Part B components. Multiple packaging sizes are available for these products.

## **Limitations**

This product is neither tested nor represented as suitable for medical or pharmaceutical uses.

## Health and Environmental Information

To support customers in their product safety needs, Dow has an extensive Product Stewardship organization and a team of product safety and regulatory compliance specialists available in each area.

For further information, please see our website, [dow.com](http://dow.com) or consult your local Dow representative.

## Disposal Considerations

Dispose in accordance with all local, state (provincial) and federal regulations. Empty containers may contain hazardous residues. This material and its container must be disposed in a safe and legal manner.

It is the user's responsibility to verify that treatment and disposal procedures comply with local, state (provincial) and federal regulations. Contact your Dow Technical Representative for more information.

## Product Stewardship

Dow has a fundamental concern for all who make, distribute, and use its products, and for the environment in which we live. This concern is the basis for our product stewardship philosophy by which we assess the safety, health, and environmental information on our products and then take appropriate steps to protect employee and public health and our environment. The success of our product stewardship program rests with each and every individual involved with Dow products - from the initial concept and research, to manufacture, use, sale, disposal, and recycle of each product.

## Customer Notice

Dow strongly encourages its customers to review both their manufacturing processes and their applications of Dow products from the standpoint of human health and environmental quality to ensure that Dow products are not used in ways for which they are not intended or tested. Dow personnel are available to answer your questions and to provide reasonable technical support. Dow product literature, including safety data sheets, should be consulted prior to use of Dow products. Current safety data sheets are available from Dow.

## How Can We Help You Today?

Tell us about your performance, design, and manufacturing challenges. Let us put our silicon-based materials experience, application knowledge, and processing experience to work for you.

**For more information** about our materials and capabilities, visit [dow.com](http://dow.com).

To discuss how we could work together to address your specific needs, go to [dow.com](http://dow.com) for a contact close to your location. Dow has customer service teams, science and technology centers, application support teams, sales offices, and manufacturing sites around the globe.

[dow.com](http://dow.com)

**NOTICE:** No freedom from infringement of any patent owned by Dow or others is to be inferred. Because use conditions and applicable laws may differ from one location to another and may change with time, Customer is responsible for determining whether products and the information in this document are appropriate for Customer's use and for ensuring that Customer's workplace and disposal practices are in compliance with applicable laws and other government enactments. The product shown in this literature may not be available for sale and/or available in all geographies where Dow is represented. The claims made may not have been approved for use in all countries. Dow assumes no obligation or liability for the information in this document. References to "Dow" or the "Company" mean the Dow legal entity selling the products to Customer unless otherwise expressly noted. NO WARRANTIES ARE GIVEN; ALL IMPLIED WARRANTIES OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE ARE EXPRESSLY EXCLUDED.



©™ Trademark of The Dow Chemical Company ("Dow") or an affiliated company of Dow  
SYLGARD™527 Silicone Dielectric Gel  
© 2017–2023 The Dow Chemical Company. All rights reserved.